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COMMISSIONER FOR PATENTS
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APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/084,787	02/25/2002	Rajendra Pendse	CPAC 1010-2 US

22470
HAYNES BEFFEL & WOLFELD LLP
P O BOX 366
HALF MOON BAY, CA 94019

CONFIRMATION NO. 6217

FORMALITIES LETTER

OC000000007681121

Date Mailed: 03/20/2002

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is missing.
A properly signed oath or declaration in compliance with 37 CFR 1.63, identifying the application by the above Application Number and Filing Date, is required.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- **The balance due by applicant is \$ 130.**

*A copy of this notice **MUST** be returned with the reply.*

Customer Service Center
Initial Patent Examination Division (703) 308-1202

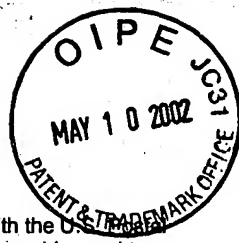
PART 2 - COPY TO BE RETURNED WITH RESPONSE

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Attorney Docket No.: CPAC 1010-2 US
USSN 10/084,787



T.D.
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Service with sufficient postage as first class mail in an envelope addressed to:
Commissioner of Patents, Washington, D.C., 20231, on May 1, 2002.

Linda Shaw
Linda Shaw

May 1, 2002
Date

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of
Rajendra PENDSE *et al.*

Application No.: 10/084,787

Filed: February 25, 2002

Title: **Super-thin high speed flip
chip package**

)
)
) Examiner: Unknown
)
) Group Art Unit: 2811
)
) Date: May 1, 2002
)
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TRANSMITTAL LETTER FOR MISSING PARTS OF APPLICATION

BOX MISSING PARTS
Commissioner of Patents
Washington, D.C. 20231

Sir:

In response to the Notice to File Missing Parts of Nonprovisional Application
dated March 20, 2002, enclosed please find:

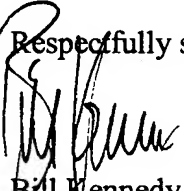
- [X] Copy of the Notice to File Missing Parts of Nonprovisional Application –
Filing Date Granted;
- [X] Combined Declaration and Power of Attorney for Utility Patent
Application with surcharge as set forth in 37 CFR 1.16(l) (\$130.00);
- [X] Check number 1753 in the amount of \$130.00 covering fees due;
- [X] Separate Letter to Official Draftsperson with one (1) sheet(s) of formal
drawings;
- [X] Copy of the executed Assignment and Form PTO-1595 filed
May 1, 2002.

Attorney Docket No.: CPAC 1010-2 US
USSN 10/084,787

PATENT

The Commissioner is hereby authorized to charge any additional fees that may be required by this paper, and to credit any overpayment, to Deposit Account No. 50-0869 (Docket No. CPAC 1010-2 US). A duplicate of this paper is enclosed.

Respectfully submitted,


Bill Kennedy
Registration No. 33,407

Reg. No 33,407

Date: May 1, 2002

HAYNES BEFFEL & WOLFELD LLP
P.O. Box 366
Half Moon Bay, CA 94019
(650) 712-0340

Attorney Docket No.: CPAC 1010-2 US
USSN 10/084,787



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Linda Shaw
Linda Shaw

May 1, 2002
Date

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)	
Rajendra PENDSE <i>et al.</i>)	
)	Examiner: Unknown
Application No.: 10/084,787)	
)	Group Art Unit: 2811
Filed: February 25, 2002)	
)	Date: May 1, 2002
Title: Super-thin high speed flip)	
chip package)	
)	

SEPARATE LETTER TO OFFICIAL DRAFTSPERSON

Official Draftsperson
Box Missing Parts
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Washington, D.C. 20231

Official Draftsperson:

In connection with the above-referenced U. S. patent application, transmitted herewith are the following papers:

[X] One (1) sheet of formal drawing(s) (Figs 1, 2, 3 and 4).

Authorization is hereby given to deduct from or credit to Deposit Account No. 50-0869 (CPAC 1010-2 US), any additional fees that may be required with this matter.

Respectfully submitted,

Bill Kennedy
Bill Kennedy
Registration No. 33,407

Date: May 1, 2002
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